

Government of India
Ministry of Communications
Department of Telecommunications
Telecommunication Engineering Centre
Khurshid Lal Bhawan, Janpath, New Delhi 110001.

No: 19-11/2023-STD/TEC

Dated 26-05-2023

Notice for Inviting Public Comments

Subject: Inviting the public comments for adoption of TSDSI transposed 3GPP specifications towards Rev 6 of ITU-R M.2012 and Rev 2 of ITU-R M.2150 into national standards by Telecommunications Engineering Centre (TEC)

Telecommunications Engineering Centre (TEC), Department of Telecommunications (DOT) has approved a policy for adoption of standards of Telecom Standards Development Society, India (TSDSI)/international standards bodies into national Standards. "[Standardisation Guide](#)" – a policy document for adoption of telecom and related ICT standards defines the process of adoption/ratification of TSDSI/international standards like institutional mechanism, process of adoption, maintenance of standards, numbering plan, stakeholder consultation etc

Telecom Standards Advisory Committee (TSAC) – a Standing apex committee under the chairmanship of DDG (Standardisation), TEC in its meeting held on 19-05-2023 has decided to initiate the process of adoption of 3GPP specifications transposed by TSDSI towards Rev 6 of ITU-R M.2012 and Rev2 of ITU-R M.2150 into national standards by TEC.

ITU-R M.2012 Rev 6 consists of new and updated specifications from 3GPP release 10 to 16 with addition of specifications from release 17. ITU-R M.2150 Rev 2 consists of new and updated specifications from 3GPP release 15 to 17.

As a next step in adoption process, all the stakeholders are requested to offer their comments on the above mentioned TSDSI transposed 3GPP documents. The details in this regard are as given below:

S. No	Item	Description
i.	Adoption of Standards	Seeking public comments on 3GPP specifications transposed by TSDSI towards Rev 6 of ITU-R M.2012 and Rev2 of ITU-R M.2150
ii.	Division	Standardisation Division, TEC
iii.	Date of Release	26 May 2023

iv.	Date of Closing	25 June 2023
v.	Comments to be mailed to	dirsted.tec-dot@gov.in , adgs.tec-dot@gov.in
vi	Document	Documents available at Annexure-I

All the stakeholders are requested to mail their comments by 25.06.2023 at dirsted.tec-dot@gov.in, adgs.tec-dot@gov.in . It may be kept into consideration while offering the comments that only technical content or the amendments affecting the technical content of standard shall be open for public comments, as per Para 6.2.4 of the Standardisation Guide.

For any query or clarification, please contact adgs.tec-dot@gov.in , dirsted.tec-dot@gov.in.



(Harsh Sharma)
Director (Standardization)
Telecommunication Engineer Centre
Email: dirsted.tec-dot@gov.in

To,

- i) Director (IT), TEC to upload the notice on TEC website for public comments
- ii) Director (IT), to upload the notice on DoT website for public comments
- iii) DG, TSDSI to upload the notice on TSDSI website for public comments

Annexure-I

The following table contains the list of transposed standards along with the URL of the file folders for each Release:

Releases	Links
Release 10 to 17 towards M.2012 (Rev. 6)	https://members.tdsi.in/s/bFQkKmBGpMpqTTm
Release 15 to 17 towards M.2150 (Rev. 2)	https://members.tdsi.in/s/3nWLFogGzE7r22g

The individual specifications can also be accessed at: <https://tdsi.in/3gpp/>